## ST1 SERIES CONNECTORS

## 1.1mm (.043") Contact Spacing, Connector for MicroSD (TransFlash ${ }^{\text {TM }}$ ) Card



## FEATURES

- Push-slide hinge type connector forTransFlashTM/ microSDTMmemory cards
- Shield characteristic is secured by the 4 ground connection points set up on the hinge cover
- Compact slim design with 1.9 mm height, 16.3 mm depth and 14.15 mm width
- Pb-freeproducts (RoHS directive)
- Lock structure prevents coming off of cover caused by falling
- User friendly with install card to a hinge
- Connector covers the card for drop/shock strength

Connector Profile (Ref.)


The ST1 Series are one-piece type connectors for TransFlash ${ }^{\text {TM }}$ (microSD ${ }^{\text {TM }}{ }^{*}$ card. High density SMT mounting type low profile connector compatible with TransFlash $h^{\top M}$ (microSDTM) cards, standardized by SanDiskCorporation/ (SDA: SD Card Association) as a compact card for various portable devices.

* TransFlash ${ }^{\text {TM }}$ is a trademark of SanDiskCorporation. MicroSD ${ }^{\text {TM }}$ is a trademark of SD Card Association.

GENERAL SPECIFICATIONS

| Number of Contacts | 8 pos. |
| :--- | :--- |
| Contact Spacing | $1.1 \mathrm{~mm}\left(.043^{\prime \prime}\right)$ |
| Contact Resistance | 100 milliohms max. |
| Dielectric withstanding Voltage | DC500V per min. |
| Operating Temperature | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature | $-10^{\circ} \mathrm{C}$ to $+60^{\circ} \mathrm{C}$ |
| Rated Current | 0.5 A per pin |
| Rated Voltage | 10 V per pin |
| Insulation Resistance | 1000 megohms min. |
| Lifetime | 10,000 times |
| Temperature Rise | $30^{\circ} \mathrm{C}$ max. |

## MATERIALS AND FINISHES

| Description | Materials/Finishes |
| :--- | :--- |
| Contact | Copper Alloy / <br> Contact Area: 0.5 $\mu \mathrm{m}$ min. Gold Plating over Nickel <br> Terminal Area: Gold flash plating over Nickel |
| Housing | Synthetic Resin / No (UL94V-0) |
| Cover | Synthetic Resin / No (UL94V-0) |

## ORDERING INFORMATION



